





# THCV219

V-by-One® HS High-speed video data transmitter

### **General Description**

THCV219 is designed to support video data transmission between the host and display.

One high-speed lane can carry up to 32bit data and 3 bits of synchronizing signals at a pixel clock frequency from 7.5MHz to 75MHz.

It has one high-speed data lane and, maximum serial data rate is 3.0Gbps/lane.

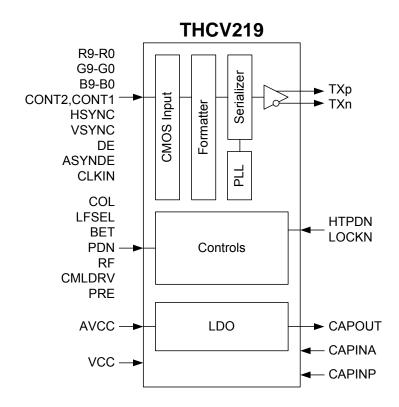
Width	Link	TTL Clock Freq.
24bit	Si/So	10MHz to 100MHz
32bit	Si/So	7.5MHz to 75MHz

Si/So: Single-in/Single-out,

### Features

- Color depth selectable: 24(8\*3)/32(10\*3)bit
- Single Link
- AC coupling for high speed lines
- Wide Range Supply Voltage 2.3~3.6V
- Package: 64 pin QFN
- Wide frequency range
- Spread Spectrum Clocking tolerant Up to 30kHz/±0.5% (center spread)
- V-by-One® HS standard Version1.4 compliant
- AEC-Q100 ESD Protection

### **Block Diagram**







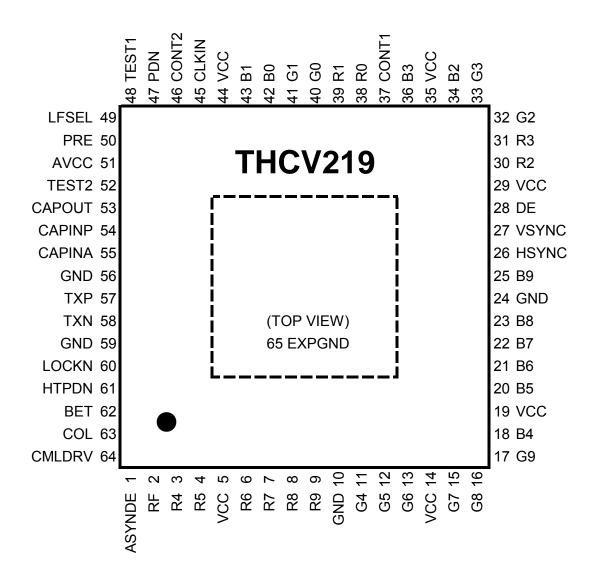
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# Pin Configuration







# Pin Description

R9-R0   9.8.7.6.4,   3,13,03,93.8   3   pixel data inputs	Pin Name	Pin#	type*	Description
B9-B0   25,23,22,12,0,   13,36,34,43,42   3   3   3   3   3   3   3   3   3	R9-R0			
Septent   18,36,34,43,42   Septent   Septen	G9-G0		13	pixel data inputs
DE	B9-B0		13	pixel data inputs
VSYNC   27   13   Vsync input	CONT1,2	37,46	13	User defined data inputs. Active only in 32bit mode.
HSYNC   26   13   Hsync input	DE	28	13	DE input
CLKIN 45 I3 Pixel clock input  TXM/P 58,57 CO High-speed CML signal output.  LOCKN 60 I3L Lock detect input. Must be connected to Rx LOCKN with a 10kΩ pull-up resistor.  HTPDN 61 I3L Hot plug detect input. Must be connected to Rx HTPDN with a 10kΩ pull-up resistor.  PDN 47 I3L Hot plug detect input. Must be connected to Rx HTPDN with a 10kΩ pull-up resistor.  PDN 47 I3L Hot plug detect input. Hs Normal operation L: Power down Pre-Emphasis level select input. H: Normal operation L: Pre-Emphasis Disable  CMLDRV 64 I3 CML Outputs drive strength select input. H: Normal drive strength select input. H: Normal drive strength L: Weak drive strength  COL** 63 I3 Data width setting. H: Cable L: 32bit Frequency range setting. H: Low frequency operation L: Normal Operation Asynchronous DE input.  ASYNDE 1 I3 Hr. Normal operation (ASYNDE function disable) L: DE input invert operation (ASYNDE function enable) Input clock triggering edge select input for latching input data H: Rising edge L: Falling edge  Field-BET operation L: Normal Operation  TEST1 48 - Test pin, must be "L" for normal operation.  TEST2 52 - Test pin, must be "L" for normal operation.  CAPOUT 53 - Test pin, must be "L" for normal operation.  TEST2 54 - Test pin, must be "L" for normal operation.  CAPOUT 55 - Reference Input for PLL circuit.Must be tied CAPOUT.  CAPINA 55 - Reference Input for Analog circuit.Must be tied CAPOUT.  CAPINA 55 - Reference Input for Analog circuit.Must be tied CAPOUT.  ONLY AND CAPOUT 51 - PS Analog Power supply Pin	VSYNC	27	13	Vsync input
TXNVP 58,57 CO High-speed CML signal output.  LOCKN 60 I3L Lock detect input. Must be connected to Rx LOCKN with a 10kΩ pull-up resistor.  HTPDN 61 I3L Must be connected to Rx HTPDN with a 10kΩ pull-up resistor.  PDN 47 I3L H: Normal operation L: Power down  PRE 50 I3 Pre-Emphasis level select input. H: Normal operation L: Pre-Emphasis Disable  CMLDRV 64 I3 H: Normal operation L: Weak drive strength  COL** 63 I3 Data width setting. H: 24bit L: 32bit  LFSEL** 49 I3 Frequency range setting. H: Low frequency operation L: Normal Operation  ASYNDE 1 I3 H: Normal operation (ASYNDE function disable) L: DE input invert operation (ASYNDE function enable) Input clock triggering edge select input for latching input data H: Rising edge L: Falling edge  BET 62 I3 Field-BET entry. H: Field BET Operation L: Normal Operation  TEST1 48 - Test pin, must be "L" for normal operation.  Decoupling capacitor pins.  CAPOUT 53 - This pin should be connected to external decoupling capacitors. Reference Input for PLL circuit. Must be tied CAPOUT.  VCC 3,14,19,29, 35,44 PS Digital Power supply Pin GND 10,24,56,59 PS Ground Pins	HSYNC	26	13	Hsync input
LOCKN 60 I3L Lock detect input. Must be connected to Rx LOCKN with a 10kΩ pull-up resistor.  HTPDN 61 I3L Must be connected to Rx HTPDN with a 10kΩ pull-up resistor.  PDN 47 I3L Power down input. H: Normal operation L: Power down PRE 50 I3 Pre-Emphasis level select input. H: Pre-Emphasis Disable  CMLDRV 64 I3 CML Outputs drive strength select input. H: Normal drive strength L: Weak drive strength  COL** 63 I3 Frequency range setting. H: Low frequency operation L: Normal Operation  ASYNDE 1 I3 Frequency range setting. H: Normal operation (ASYNDE function disable) L: DE input invert operation (ASYNDE function enable)  RF 2 I3 H: Rising edge L: Falling edge  BET 62 I3 Field-BET entry. H: Field BET Operation  TEST1 48 - Test pin, must be "L" for normal operation.  TEST2 52 - Test pin, must be "L" for normal operation.  CAPOUT 53 - Reference Input for PLL circuit. Must be tied CAPOUT.  CAPINA 55 - Reference Input for Analog circuit. Must be tied CAPOUT.  VCC 5.14,19,29, 35,44 PS Ground Pins	CLKIN	45	13	Pixel clock input
LOCKN 60 I3L Lock detect input. Must be connected to Rx LOCKN with a 10kΩ pull-up resistor.  HTPDN 61 I3L Must be connected to Rx HTPDN with a 10kΩ pull-up resistor.  PDN 47 I3L Must be connected to Rx HTPDN with a 10kΩ pull-up resistor.  POWER 64 I3 Pre-Emphasis level select input. H: Normal operation L: Power down  Pre-Emphasis level select input. H: Pre-Emphasis Disable  CMLDRV 64 I3 CML Outputs drive strength select input. H: Normal drive strength select input. H: Normal drive strength L: Weak drive strength  Data width setting. H: 24bit L: 32bit  Frequency range setting. H: Low frequency operation L: Normal Operation  Asynchronous DE input. H: Normal operation (ASYNDE function disable)  L: DE input invert operation (ASYNDE function enable)  Input clock triggering edge select input for latching input data H: Rising edge L: Falling edge  BET 62 I3 Field-BET entry. H: Field BET Operation L: Normal Operation  TEST1 48 - Test pin, must be "L" for normal operation.  TEST2 52 - Test pin, must be "L" for normal operation.  Decoupling capacitor pins.  This pin should be connected to external decoupling capacitors. Recommended Capacitance is 2.2uF  CAPINP 54 - Reference Input for PLL circuit. Must be tied CAPOUT.  VCC 5.14,19,29, 35,44 PS Digital Power supply Pin GND 10,24,56,59 PS Ground Pins	TXN/P	58,57	СО	High-speed CML signal output.
HTPDN 61 I3L Hot plug detect input. Must be connected to Rx HTPDN with a 10kΩ pull-up resistor.  PDN 47 I3L Power down input. H: Normal operation L: Power down  PRE 50 I3 Pre-Emphasis level select input. H: Pre-Emphasis Disable  CMLDRV 64 I3 CML Outputs drive strength select input. H: Normal drive strength select input. H: Normal drive strength L: Weak drive strength  COL** 63 I3 Data width setting. H: 24bit L: 32bit  LFSEL** 49 I3 Frequency range setting. H: Low frequency operation L: Normal Operation  ASYNDE 1 I3 H: Normal operation (ASYNDE function disable)  L: DE input invert operation (ASYNDE function enable)  Input clock triggering edge select input for latching input data H: Rising edge L: Falling edge  BET 62 I3 H: Field BET Operation L: Normal Operation  TEST1 48 - Test pin, must be "L" for normal operation.  TEST2 52 - Test pin, must be "L" for normal operation.  CAPOUT 53 - This pin should be connected to external decoupling capacitors. Recommended Capacitance is 2.2uF  CAPINP 54 - Reference Input for PLL circuit.Must be tied CAPOUT.  VCC 5,14,19,29, 35,44 PS Digital Power supply Pin AVCC 51 PS Analog Power supply Pin  AVCC 51 PS Analog Power supply Pin	LOCKN	60	I3L	Lock detect input.
PDN 47 I3L Power down input. H: Normal operation L: Power down  PRE 50 I3 Pre-Emphasis level select input. H: Pre-Emphasis Enable L: Pre-Emphasis Disable  CMLDRV 64 I3 CML Outputs drive strength select input. H: Normal drive strength L: Weak drive strength  Data width setting. H: 24bit L: 32bit  LFSEL** 49 I3 Frequency range setting. H: Low frequency operation L: Normal Operation  Asynchronous DE input. H: Normal operation (ASYNDE function disable) L: DE input invert operation (ASYNDE function enable)  RF 2 I3 Input invert operation (ASYNDE function enable) Input clock triggering edge select input for latching input data H: Rising edge L: Falling edge  Field-BET entry. H: Field BET Operation L: Normal Operation  TEST1 48 - Test pin, must be "L" for normal operation.  CAPOUT 53 - This pin should be connected to external decoupling capacitors. Recommended Capacitance is 2.2uF  CAPINA 55 - Reference Input for Analog circuit.Must be tied CAPOUT.  VCC 35,14,19,29, 35,44 PS Digital Power supply Pins  AVCC 51 PS Analog Power supply Pin  GND 10,24,56,59 PS Ground Pins	HTPDN	61	I3L	Hot plug detect input.
PRE 50   13   Pre-Emphasis level select input.   H : Pre-Emphasis Disable   CML Outputs drive strength select input.   H : Normal drive strength select input.   H : Normal drive strength   L : Weak drive strength   Data width setting.   H : 24bit   L : 32bit   L : 32bit   H : 24bit   L : 32bit   H : 24bit   L : 32bit   L : 32bit   H : 24bit   L : 32bit   L : 32bit   H : 24bit   L : 32bit   L : 32bit   H : 24bit   L : 32bit   L : 32bit   H : 24bit   L : 32bit   L : 32bit	PDN	47	I3L	Power down input.
CMLDRV 64 B CML Outputs drive strength select input. H: Normal drive strength L: Weak drive strength  COL** 63 B Data width setting. H: 24bit L: 32bit  EFSEL** 49 B Frequency range setting. H: Low frequency operation L: Normal Operation  Asynchronous DE input.  ASYNDE 1 B H: Normal operation (ASYNDE function disable) L: DE input invert operation (ASYNDE function enable)  RF 2 B Input clock triggering edge select input for latching input data H: Rising edge L: Falling edge  BET 62 B Field-BET entry. H: Field BET Operation L: Normal Operation  TEST1 48 - Test pin, must be "L" for normal operation.  TEST2 52 - Test pin, must be "L" for normal operation.  CAPOUT 53 - This pin should be connected to external decoupling capacitors. Recommended Capacitance is 2.2uF  CAPINP 54 - Reference Input for PLL circuit.Must be tied CAPOUT.  CAPINA 55 - Reference Input for Analog circuit.Must be tied CAPOUT.  VCC 5,14,19,29, 35,44 PS Digital Power supply Pin  AVCC 51 PS Analog Power supply Pin  GND 10,24,56,59 PS Ground Pins	PRE	50	13	Pre-Emphasis level select input.
COL** 63   B   Data width setting.	CMLDRV	64	13	CML Outputs drive strength select input.
LFSEL** 49 13 Frequency range setting. H: Low frequency operation L: Normal Operation  Asynchronous DE input. H: Normal operation (ASYNDE function disable) L: DE input invert operation (ASYNDE function enable)  RF 2 13 Input clock triggering edge select input for latching input data H: Rising edge L: Falling edge  BET 62 13 Field-BET entry. H: Field BET Operation L: Normal Operation  TEST1 48 - Test pin, must be "L" for normal operation.  TEST2 52 - Test pin, must be "L" for normal operation.  CAPOUT 53 - This pin should be connected to external decoupling capacitors. Recommended Capacitance is 2.2uF  CAPINP 54 - Reference Input for PLL circuit.Must be tied CAPOUT.  CAPINA 55 - Reference Input for Analog circuit.Must be tied CAPOUT.  VCC 5,14,19,29, 35,44 PS Digital Power supply Pins  AVCC 51 PS Analog Power supply Pin  GND 10,24,56,59 PS Ground Pins	COL**	63	13	Data width setting.
ASYNDE 1 1	LFSEL**	49	13	Frequency range setting.
RF 2   13   Input clock triggering edge select input for latching input data H: Rising edge L: Falling edge   H: Rising edge L: Falling edge    BET 62   13   Field-BET entry. H: Field BET Operation L: Normal Operation    TEST1 48 - Test pin, must be "L" for normal operation.  TEST2 52 - Test pin, must be "L" for normal operation.  CAPOUT 53 - This pin should be connected to external decoupling capacitors. Recommended Capacitance is 2.2uF  CAPINP 54 - Reference Input for PLL circuit.Must be tied CAPOUT.  CAPINA 55 - Reference Input for Analog circuit.Must be tied CAPOUT.  VCC 5,14,19,29, 35,44 PS Digital Power supply Pins  AVCC 51 PS Analog Power supply Pin  GND 10,24,56,59 PS Ground Pins	ASYNDE	1	13	Asynchronous DE input. H: Normal operation (ASYNDE function disable)
BET 62   B Field-BET entry. H: Field BET Operation L: Normal Operation  TEST1 48 - Test pin, must be "L" for normal operation.  TEST2 52 - Test pin, must be "L" for normal operation.  Decoupling capacitor pins.  CAPOUT 53 - This pin should be connected to external decoupling capacitors. Recommended Capacitance is 2.2uF  CAPINP 54 - Reference Input for PLL circuit.Must be tied CAPOUT.  CAPINA 55 - Reference Input for Analog circuit.Must be tied CAPOUT.  VCC 514,19,29, 35,44 PS Digital Power supply Pins  AVCC 51 PS Analog Power supply Pin  GND 10,24,56,59 PS Ground Pins	RF	2	13	Input clock triggering edge select input for latching input data
TEST1 48 - Test pin, must be "L" for normal operation.  TEST2 52 - Test pin, must be "L" for normal operation.  Decoupling capacitor pins.  This pin should be connected to external decoupling capacitors.  Recommended Capacitance is 2.2uF  CAPINP 54 - Reference Input for PLL circuit.Must be tied CAPOUT.  CAPINA 55 - Reference Input for Analog circuit.Must be tied CAPOUT.  VCC 5,14,19,29, 35,44 PS Digital Power supply Pins  AVCC 51 PS Analog Power supply Pin  GND 10,24,56,59 PS Ground Pins	BET	62	13	Field-BET entry.
CAPOUT  53  - This pin should be connected to external decoupling capacitors. Recommended Capacitance is 2.2uF  CAPINP  54  - Reference Input for PLL circuit.Must be tied CAPOUT.  CAPINA  55  - Reference Input for Analog circuit.Must be tied CAPOUT.  VCC  5,14,19,29, 35,44  PS  Digital Power supply Pins  AVCC  51  PS  Analog Power supply Pin  GND  10,24,56,59  PS  Ground Pins	TEST1	48	-	
CAPOUT  53  - This pin should be connected to external decoupling capacitors.  Recommended Capacitance is 2.2uF  CAPINP  54  - Reference Input for PLL circuit.Must be tied CAPOUT.  CAPINA  55  - Reference Input for Analog circuit.Must be tied CAPOUT.  VCC  5,14,19,29, 35,44  PS  Digital Power supply Pins  AVCC  51  PS  Analog Power supply Pin  GND  10,24,56,59  PS  Ground Pins	TEST2	52	-	Test pin, must be "L" for normal operation.
CAPINA 55 - Reference Input for Analog circuit.Must be tied CAPOUT.  VCC 5,14,19,29, 35,44 PS Digital Power supply Pins  AVCC 51 PS Analog Power supply Pin  GND 10,24,56,59 PS Ground Pins	CAPOUT	53	-	This pin should be connected to external decoupling capacitors.
CAPINA 55 - Reference Input for Analog circuit.Must be tied CAPOUT.  VCC 5,14,19,29, 35,44 PS Digital Power supply Pins  AVCC 51 PS Analog Power supply Pin  GND 10,24,56,59 PS Ground Pins	CAPINP	54	-	
AVCC         51         PS         Analog Power supply Pin           GND         10,24,56,59         PS         Ground Pins	CAPINA	55	-	Reference Input for Analog circuit.Must be tied CAPOUT.
AVCC 51 PS Analog Power supply Pin GND 10,24,56,59 PS Ground Pins	VCC		PS	Digital Power supply Pins
GND 10,24,56,59 PS Ground Pins	AVCC	·	PS	Analog Power supply Pin
		10,24,56,59	PS	•,
	EXPGND		PS	Exposed Pad Ground

<sup>\*</sup>type symbol

I3=3.3v CMOS input, I3L=Low Speed 3.3v CMOS input

CO=CML output, PS=Power Supply

COL pin and/or LFSEL pin level shall not be changed during operation. If ether pin level is changed during operation, PDN shall be toggled (H-> L -> H) after the change.

<sup>\*\*</sup>COL, LFSEL pin





# **Functional Description**

#### **Functional Overview**

With V-by-One<sup>®</sup> HS proprietary encoding scheme and CDR (Clock and Data Recovery) architecture, THCV219 enables transmission of 8/10 bit RGB, 2bits of user-defined data (CONT), synchronizing signals HSYNC, VSYNC, and DE by a pair cable with minimal external components.

THCV219 inputs CMOS/TTL data (including video data, CONT, HSYNC, VSYNC, and DE) and serializes video data and synchronizing signals separately, depending on the polarity of DE. DE is a signal which indicates whether video or synchronizing data are active. When DE is high, it serializes video data inputs into differential data streams. And it transmits serialized synchronizing data when DE is low.

THCV219 can operate for a wide range of a serial bit rate from 600Mbps to 3.0Gbps.

It does not need any external frequency reference, such as a crystal oscillator.

#### Internal Reference Output/Input Function (CAPOUT, CAPINA, CAPINP)

An internal regulator produces the 1.2V (CAPOUT). This 1.2V linear regulator can not supply any other external loads. Bypass CAPOUT to GND with 2.2uF.

CAPINP supplies reference voltage for internal PLL, and CAPINA supplies reference voltage for any internal analog circuit. Bypass CAPINP/CAPINA to GND with 0.1uF to remove high frequency noise. CAPOUT, CAPINA and CAPINP must be tied together.

Analog power supply AVCC is supposed to be stabilized with de-coupling capacitor and series noise filter (for example, ferrite bead).

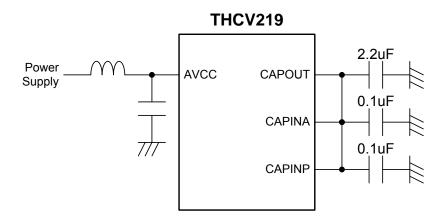


Figure 1. Connection of CAPOUT, CAPINA, CAPINP and Decoupling Capacitor

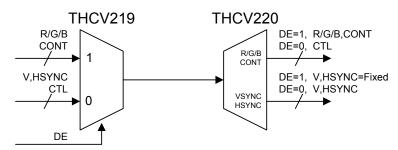




#### Data Enable

Figure 2 is the conceptual diagram of the basic operation of the chipset. THCV220 in Figure 2 is an example of V-by-One® HS Receiver.

There are some requirements for DE. Figure 3 shows the timing diagram of it.



CTL are particular assigned bit among R/G/B,CONT that can carry arbitrary data during DE=0 period.

Figure 2. Conceptual diagram of the basic operation of the chipset

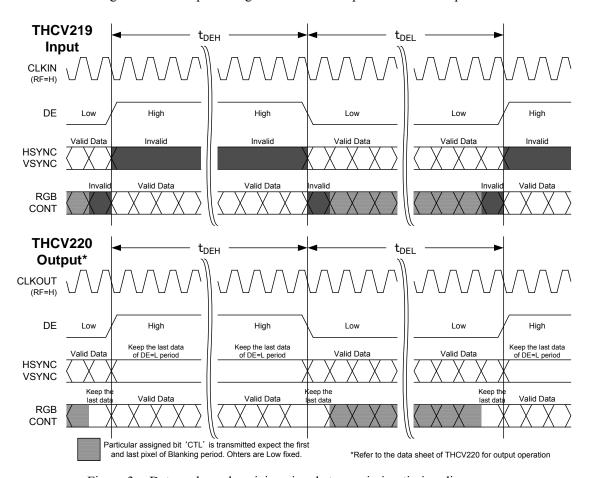


Figure 3. Data and synchronizing signals transmission timing diagram

Table 1. DE requirement

symbol	Parameter	min.	typ.	max.	Unit
tDEH	DE=High Duration	2tTCIP			sec
tDEL	DE=Low Duration	2tTCIP			sec





#### **ASYNDE**

If ASYNDE input is Low, DE input is inverted before V-by-One® HS processing. RGB/CONT Data is transmitted during DE input=Low. Please be careful this inverted DE is outputted from V-by-One® HS receiver, which may cause polarity mismatch against following system requirement.

#### Color Depth and Frequency Range Select function

THCV219 supports a variety of data width and frequency range. Refer to Table 2 for details.

COL pin and/or LFSEL pin level shall not be changed during operation. If ether pin level is changed during operation, PDN shall be toggled (H-> L-> H) after the change.

COL	LFSEL	Description	Freq. Range
	L	32bit	15 to 75M
L	Н	32bit Low frequency mode	7.5 to 30M
Н	L	24bit	20 to 100M
	Н	24bit Low frequency mode	10 to 40M

Table 2. operation mode select

#### **Hot-Plug Function**

HTPDN indicates connecting condition between the Transmitter and the Receiver. HTPDN of the transmitter side is high when the Receiver is not active or not connected. Then Transmitter can enter into the power down mode. HTPDN is set to Low by the Receiver when Receiver is active and connects to the Transmitter, and then Transmitter must start up and transmit CDR training pattern for link training. HTPDN is open drain output at the receiver side. Pull-up resistor is needed at the transmitter side.

HTPDN connection between the Transmitter and the Receiver can be omitted as an application option. In this case, HTPDN at the Transmitter side should always be taken as Low.

#### Lock Detect Function

LOCKN indicates whether the CDR PLL is in the lock state or not. LOCKN at the Transmitter input is set to High by pull-up resistor when Receiver is not active or at the CDR PLL training state. LOCKN is set to Low by the Receiver when CDR lock is done. Then the CDR training mode finishes and Transmitter shifts to the normal mode. LOCKN is open drain output at the receiver side. Pull-up resistor is needed at the transmitter side.

When HTPDN is included in an application, the LOCKN signal should only be considered when the HTPDN is pulled low by the Receiver.

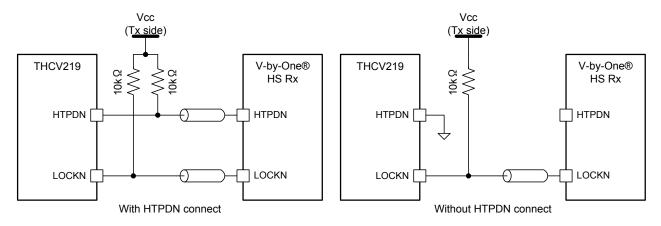


Figure 4. Hot-plug and Lock detect scheme





# Pre-emphasis and Drive Select Function

Pre-emphasis can equalize severe signal degradation caused by long-distance or high-speed transmission. The PRE pin selects the strength of pre-emphasis.

CMLDRV controls CML output swing level. See Table 3.

Table 3. Pre-emphasis and Drive Select function table

		Description			
PRE	CMLDRV	Swing level	Pre-emphasis		
L		400mV diff p-p	OdP		
L	Н	600mV diff p-p	0dB		
L L		400mV diff p-p	6dB		
H	Н	600mV diff p-p	3.5dB		

#### Power Down Function

Setting the PDN pin low places THCV219 in the power-down mode. Internal circuitry turns off and the TXP/N outputs turn to High level.

Table 4. Power Down function table

PDN	Description
L	Power Down
Н	Normal Operation



### Field BET Operation

In order to help users to check validity of CML high-speed serial line, THCV219 has an operation mode in which they act as a bit error tester (BET). In this mode, THCV219 internally generates test pattern which is then serialized onto the CML high-speed line. THCV220 which is an example or Rx device also has BET function mode. THCV220 receives the data stream and checks bit errors.

This "Field BET" mode is activated by setting BET= H both on THCV219 and THCV220. The generated data pattern is then 8b/10b encoded, scrambled, and serialized onto the CML channel. As for THCV220, the internal test pattern check circuit gets enabled and reports result on a certain pin named BETOUT. The BETOUT pin goes LOW whenever bit errors occur, or it stays HIGH when there is no bit error. Please refer to Table 5.

THCV219	THCV220	Figure 5 Condition				
Figure 6. BET	Figure 7. BET	Figure 5. Condition				
L	L	Normal Operation				
н		Field BET Operation				

Table 5. Field BET operation pin settings

Table 6. THCV220 Field BET result

BETOUT	Output	
L	Bit error occurred	
Н	No error	

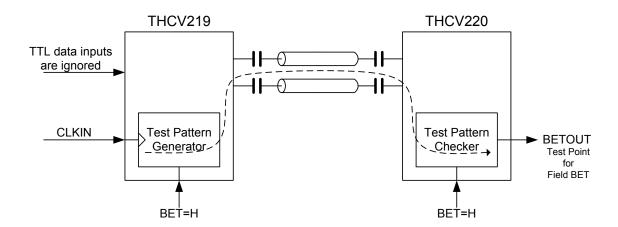


Figure 8. Field BET Configuration





# Absolute Maximum Ratings\*

Parameter	min.	typ.	max.	Unit
Supply Voltage(VCC,AVCC)	-0.3	-	+4.0	V
CMOS Input Voltage	-0.3	-	VCC+0.3	V
CML Transmitter Output Voltage	-0.3	-	CAPINA+0.3	V
Output Current	-30	-	30	mA
Storage Temperature	-55	-	+125	လူ
Junction Temperature	-	-	+125	လူ
Reflow Peak Temperature/Time	-	-	+260/10sec	လူ
Maximum Power Dissipation @+25°C	-	-	3.9	W

<sup>\* &</sup>quot;Absolute Maximum Ratings" are those values beyond which the safety of the device can not be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.

# **Recommended Operating Conditions**

Parameter	min.	typ.	max.	Unit
	2.3	2.5	2.7	V
Supply Voltage (VCC,AVCC)	2.6	2.8	3.0	V
	3.0	3.3	3.6	V
Operating Temperature	-40		85	°C

# **Electrical Specifications**

# **CMOS DC Specifications**

		Over recommended o	perating supply and	temperature range	s unless otherwise	specified.
symbol	Parameter	conditions	min.	typ.	max.	Unit
IIH	Input Leak Current High		-10		+10	uA
IIL	Input Leak Current Low		-10		+10	uA
<b>VCAPOUT</b>	Regulator output Voltage			1.20		V

					VCC	=3.3±0.3V
symbol	Parameter	conditions	min.	typ.	max.	Unit
VIH	High Loyal Input Valtage	13	2.0		VCC	V
VIII	High Level Input Voltage	I3L	2.1		VCC	V
VIL	Low Level Input Voltage	13	0		0.8	V
VIL	Low Level Iliput Voltage	I3L	0		0.7	V

					VCC	C=2.8±0.2V
symbol	Parameter	conditions	min.	typ.	max.	Unit
VIH	Lligh Lovel Innet Voltage	13	1.8		VCC	V
VIII	High Level Input Voltage	I3L	1.9		VCC	V
VIL	Low Level Input Voltage	13	0		0.7	V
V IL		131	0		0.6	V

					VCC=	2.5±0.2V
symbol	Parameter	conditions	min.	typ.	max.	Unit
VIH	High Level Input Voltage	13	1.7		VCC	V
VIH		I3L	1.6		VCC	V
VIL	Low Level Input Voltage	13	0		0.7	V
		I3L	0		0.5	V





# **CML DC Specifications**

Over recommended operating supply and temperature ranges unless otherwise specified

		Over recommended o	perating supply and	i temperature range		specilieu.
symbol	Parameter	conditions	min.	typ.	max.	Unit
VTOD	CML Differential Mode Output Voltage	CMLDRV=L	133	200	267	mV
VIOD	CIVIL Differential Wode Output Voltage	CMLDRV=H	200	300	400	mV
		PRE=L		0		%
PRE	CML Pre-emphasis Level	PRE=H, CMLDRV=L		100		%
		PRE=H, CMLDRV=H		50		%
	CML Common Mode Output Voltage	PRE=L	1.2 - VTOD			V
VTOC		PRE=H, CMLDRV=L	1.2 - 2 * VTOD			V
		PRE=H, CMLDRV=H		1.2 - 1.5 * VTOD		V
ПОН	CML Output Leak Current High	PDN=L, TXP/N=1.2V			±30	uA
ITOS	CML Output Short Circuit Current	PDN=L, TXP/N=0V	-80			mA

# Supply Currents

Over recommended operating supply and temperature ranges unless otherwise specified.

symbol	Parameter	conditions	min.	typ.	max.	Unit
пссw	Transmitter Cumply Current	COL=L			100	m 1
IICCVV	Transmitter Supply Current	PRE=H		100	mA	
пссs	Transmitter Power Down	PDN=L		1.2	10	mA
11003	Supply Current	All Inputs =Fixed LorH		1.2	10	IIIA

# **Switching Characteristics**

Over recommended operating supply and temperature ranges unless otherwise specified

		Over recommended t	perating supply and	i temperature range	s uniess onerwise	specilieu.
symbol	Parameter	conditions	min.	typ.	max.	Unit
tTRF	CML Output Rise and Fall Time(20%-80%)		50		150	ps
		COL=H, LFSEL=L	10		50	ns
tTCIP	CLKIN Period	COL=H, LFSEL=H	25		100	ns
LICIP	CLKIN Fellou	COL=L, LFSEL=L	13.34		66.66	ns
		50   COL=H, LFSEL=L		133.33	ns	
tTCH	CLK IN High Time		0.35tTCIP	0.5tTCIP	0.65tTCIP	ns
tTCL	CLK IN Low Time		0.35tTCIP	0.5tTCIP	0.65tTCIP	ns
tTS	TTL Data Setup to CLK IN		2.0			ns
tTH	TTL Data Hold to CLK IN		0.6			ns
tTCD	Input Clock to Output Data Delay	COL=H	typ tTCIP	10.6tTCIP+1.7	typ. + tTCIP	ns
LICD	Input Clock to Output Data Delay	50   COL=H, LFSEL=L	typ. + tTCIP	ns		
tTPD	Power On to PDN High Delay		0			ns
tTPLL0	PDN High to CML Output Delay				10	ms
tTPLL1	PDN Low to CML Output High Fix Delay				20	ns
tTNP0	LOCKN High to Training Pattern Output Delay				10	ms
tTNP1	LOCKN Low to Data Pattern Output Delay				10	ms





# AC Timing Diagrams and Test Circuits

# CMOS/TTL Input Switching Characteristics

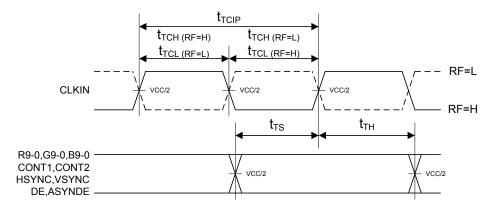
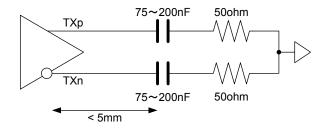


Figure 9. CMOS/TTL Input Switching Timing Diagrams

# CML Output Switching Characteristics



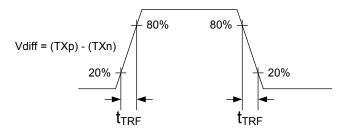


Figure 10. CML buffer Switching Timing Diagrams and Test Circuit





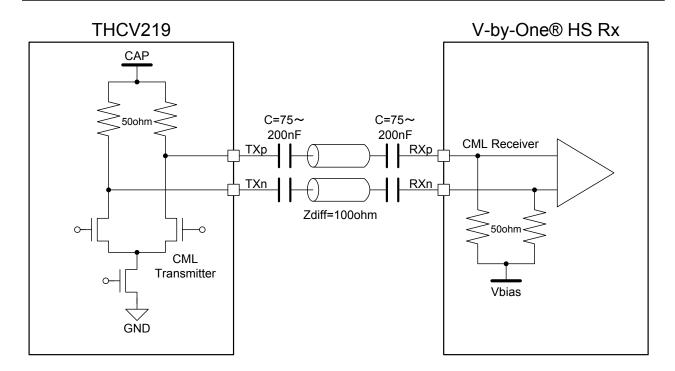


Figure 11. CML buffer scheme





# **Latency Characteristics**

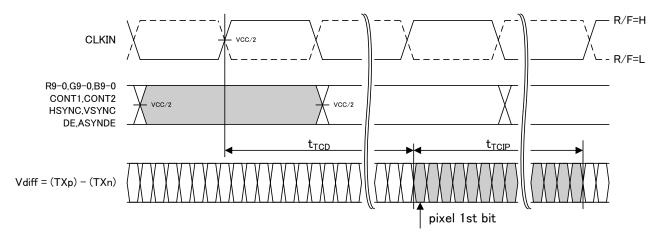


Figure 12. THCV219 Latency

# Data output Sequence

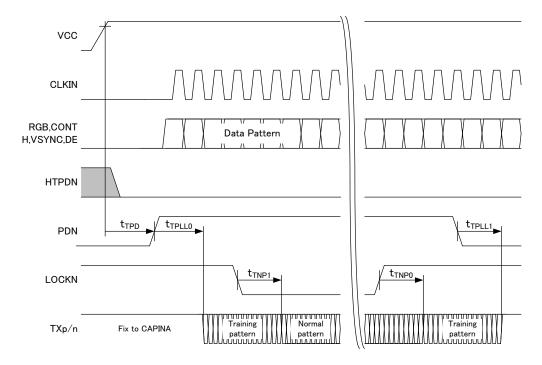


Figure 13. THCV219 Sequence





# Input Data Mapping

Table 7. CMOS/TTL Input Data Mapping

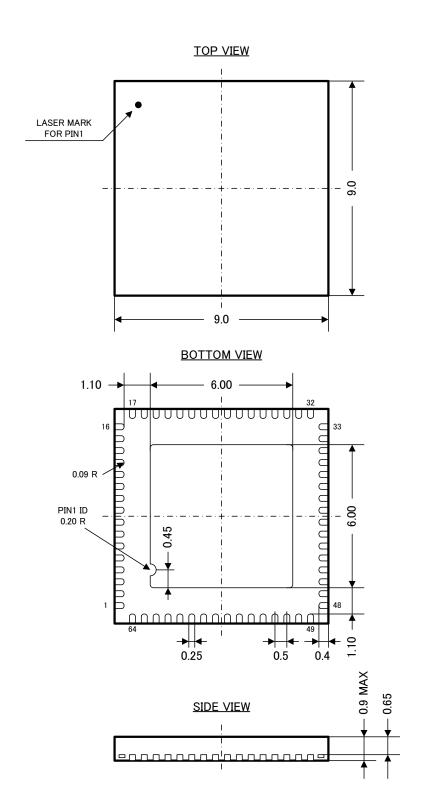
			mitter		
	ignals	-	in Name	Symbol defined	
10bit	8bit	10bit	8bit	by V-by-One® HS	
(30bpp)	(24bpp)	(30bpp)	(24bpp)		
R0 *1	-	R0	-	D30	
R1 *1	-	R1	-	D31	
R2	R0	R2	R2	D0	
R3	R1	R3	R3	D1	
R4	R2	R4	R4	D2	
R5	R3	R5	R5	D3	
R6	R4	R6	R6	D4	
R7	R5	R7	R7	D5	
R8	R6	R8	R8	D6	
R9	R7	R9	R9	D7	
G0 *1	1	G0	-	D28	
G1 *1	-	G1	-	D29	
G2	G0	G2	G2	D8	
G3	G1	G3	G3	D9	
G4	G2	G4	G4	D10	
G5	G3	G5	G5	D11	
G6	G4	G6	G6	D12	
G7	G5	G7	G7	D13	
G8	G6	G8	G8	D14	
G9	G7	G9	G9	D15	
B0 *1	-	B0	-	D26	
B1 *1	-	B1	-	D27	
B2 *1	B0 *1	B2	B2	D16	
B3 *1	B1 *1	B3	B3	D17	
B4 *1	B2 *1	B4	B4	D18	
B5 *1	B3 *1	B5	B5	D19	
B6 *1	B4 *1	B6	B6	D20	
B7 *1	B5 *1	B7	B7	D21	
B8 *1	B6 *1	B8	B8	D22	
B9 *1	B7 *1	B9	B9	D23	
CONT1 *1	-	CONT1	-	D24	
CONT2 *1	-	CONT2	-	D25	
HSYNC	HSYNC	HSYNC	HSYNC	HSYNC	
VSYNC	VSYNC	VSYNC	VSYNC	VSYNC	
DE	DE	DE	DE	DE	

<sup>\*1</sup> CTL bits, which are carried during DE=Low except the 1<sup>st</sup> and the last pixel.





# **Package**







#### **Notices and Requests**

- 1. The product specifications described in this material are subject to change without prior notice.
- 2. The circuit diagrams described in this material are examples of the application which may not always apply to the customer's design. We are not responsible for possible errors and omissions in this material. Please note if errors or omissions should be found in this material, we may not be able to correct them immediately.
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- 6. Despite our utmost efforts to improve the quality and reliability of the product, faults will occur with a certain small probability, which is inevitable to a semi-conductor product. Therefore, you are encouraged to have sufficiently redundant or error preventive design applied to the use of the product so as not to have our product cause any social or public damage.
- 7. Please note that this product is not designed to be radiation-proof.
- 8. Testing and other quality control techniques are used to this product to the extent THine deems necessary to support warranty for performance of this product. Except where mandated by applicable law or deemed necessary by THine based on the user's request, testing of all functions and performance of the product is not necessarily performed.
- 9. Customers are asked, if required, to judge by themselves if this product falls under the category of strategic goods under the Foreign Exchange and Foreign Trade Control Law.
- 10. The product or peripheral parts may be damaged by a surge in voltage over the absolute maximum ratings or malfunction, if pins of the product are shorted by such as foreign substance. The damages may cause a smoking and ignition. Therefore, you are encouraged to implement safety measures by adding protection devices, such as fuses.





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